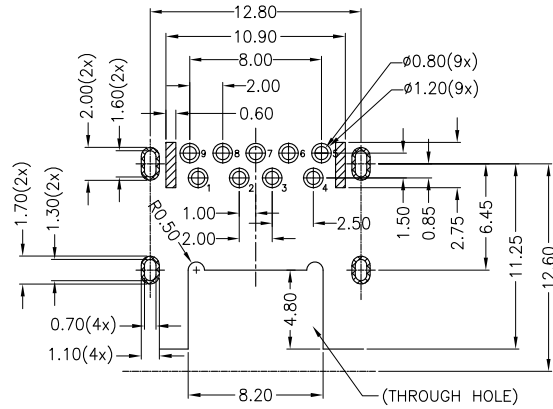
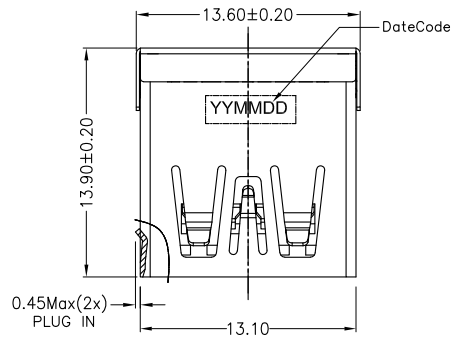
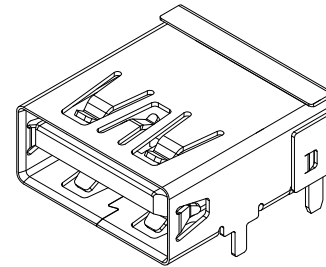
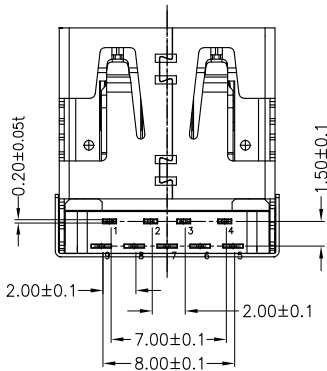
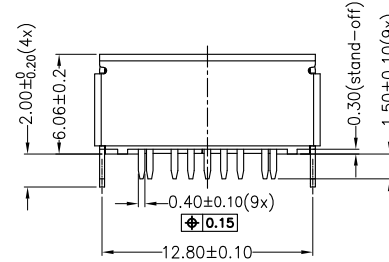
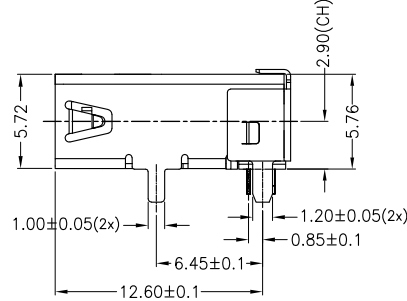
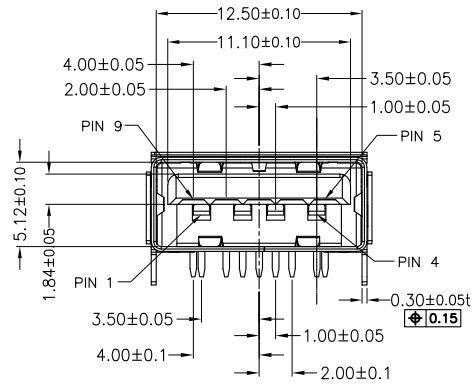


The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements

RoHS+HF



RECOMMENDED PCB LAYOUT (TOP VIEW)
GENERAL TOLERANCES: ±0.05 (t=1.2)



NOTE:

- 1.MATERIAL SPECIFICATION:
1-1.HOUSING:PA9T BULE UL94V-0
1-2.CONTACTS:C5210
1-3.SHELL:STAINLESS STEEL SUS304.
- 2.PLATING SPECIFICATION:
2-1.CONTACTS:
Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
2-2. SHELL:
Ni 30u" MIN. UNDER PLATED OVER ALL.
- 3.MECHANICAL PERFORMANCE:
3-1.INSERTION FORCE: 3.57kgf MAX
3-2.REMOVAL FORCE: 1.02kgf MIN
3-3.DURABILITY: 5000 CYCLES.
- 4.ELECTRICAL PERFORMANCE:
4-1.CURRENT RATING:1.5A
4-2.VOLTAGE RATING:30V MAX
4-3.Contact Resistance: 30m Ohm Max.
4-4.INSULATION RESISTANCE: 100MΩ MIN
4-5.Dielectric Withstanding Voltage: 100V AC Min
- 5.ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -40°C~+85°C.
- 6.DATECODE INFORMATION:
YYMMDD (Y:YEAR M:MONTH D:DATE)
- 7.PACKAGE SPEC:REEL

WLU3F9-09 1 X X 0033

PLATING: 1-G/F 2-AU 3U" 5-AU 15U" 6-AU 30U"
COLOUR: A:BLACK K:WHITE

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART. NO:	DWG. NO:	 WanLian Teconology Co., Ltd	
A0	NEW RELEASE	21. 01. 13		LINEAR	ANGLES	APPROVED	Wang_jr	21. 01. 13	WLU3F9-091XX0033	ENDE05		
				0. 0±0. 35	X° REF±6°		DESIGNER	Ding_bo	21. 01. 13	TITLE: USB3.0 AF 单层 DIP 四脚插板		
				UNIT: mm	0. 00±0. 25	X° ±3°		Ou_jian	21. 01. 13			
			SIZE: A4	0. 000±0. 10	X° X' ±2°	DRAWN					REV: A0	SHEET: 1/1